

NUF4310MN

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Low Capacitance 4-Line EMI Filter with ESD Protection in WDFN8 Package

This device is a 4 line EMI filter array for wireless applications. Greater than -25 dB attenuation is obtained at frequencies from 800 MHz to 4.0 GHz. The NUF4310MN has a cut-off frequency of 185 MHz. This WDFN package is specifically designed to enhance EMI filtering for low-profile or slim design electronics especially where space and height is a premium. It also offers ESD protection—clamping transients from static discharges. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 20 Discrete Components
- Compliance with IEC61000-4-2 (Level 4)
>8 kV (Contact) [I/O Pins to GND]
- WDFN Package, 1.6 x 1.0 mm
- Moisture Sensitivity Level 1
- ESD Ratings: Machine Model = C
Human Body Model = 3B
- This is a Pb-Free Device*

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Low Profile Package; Typical Height of 0.75 mm
- Design-Friendly and Easy-to-Use Pin Configurations, Particularly for Portable Electronics
- Integrated Solution Offers Cost and Space Savings in WDFN Package
- Reduces Parasitic Inductances Which Offer a More “Ideal” Low Pass Filter Response
- Integrated Solution Improves System Reliability

Applications

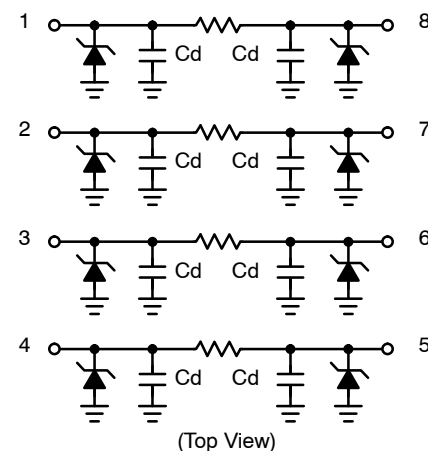
- EMI Filtering and ESD Protection for Data Lines
- Keypad Interface and Protection for Portable Electronics
- Bottom Connector Interface for Mobile Handsets
- Notebook Computers and Digital Cameras
- LCD Display Interface in Mobile Handsets
- Camera Display Interface in Mobile Handsets

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



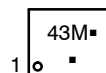
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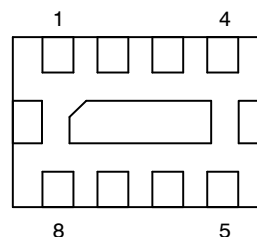
WDFN8
CASE 511AF

MARKING DIAGRAM



43 = Specific Device Code
M = Date Code
▪ = Pb-Free Package
(Note: Microdot may be in either location)

PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping†
NUF4310MNTAG	WDFN8 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
ESD Discharge IEC61000-4-2 Contact Discharge	V_{PP}	8.0	kV
Operating Temperature Range	T_{OP}	-40 to 85	°C
Storage Temperature Range	T_{STG}	-55 to 150	°C
Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 seconds)	T_L	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Maximum Reverse Working Voltage	V_{RWM}				5.0	V
Breakdown Voltage	V_{BR}	$I_R = 1.0\text{ mA}$	6.0	7.0	8.0	V
Leakage Current	I_R	$V_{RWM} = 3.3\text{ V}$			100	nA
Resistance	R_A	$I_R = 10\text{ mA}$	85	100	115	Ω
Capacitance (Notes 1 and 2)	Cd	$V_R = 2.5\text{ V}$, $f = 1.0\text{ MHz}$	7.2	9.0	10.8	pF
Cut-Off Frequency (Note 3)	f_{3dB}	Above this frequency, appreciable attenuation occurs		185		MHz

1. Measured at 25°C .
2. Total Line Capacitance is two times the Diode Capacitance (Cd).
3. 50 Ω source and 50 Ω load termination.

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TYPICAL PERFORMANCE CURVES

($T_A = 25^\circ\text{C}$ unless otherwise specified)

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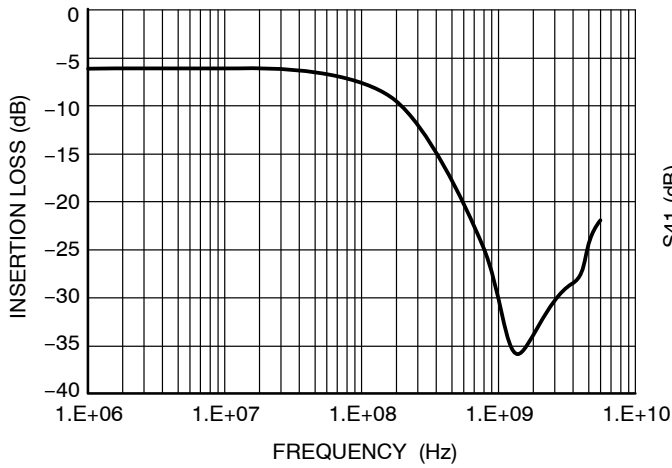


Figure 1. Typical Insertion Loss Characteristic

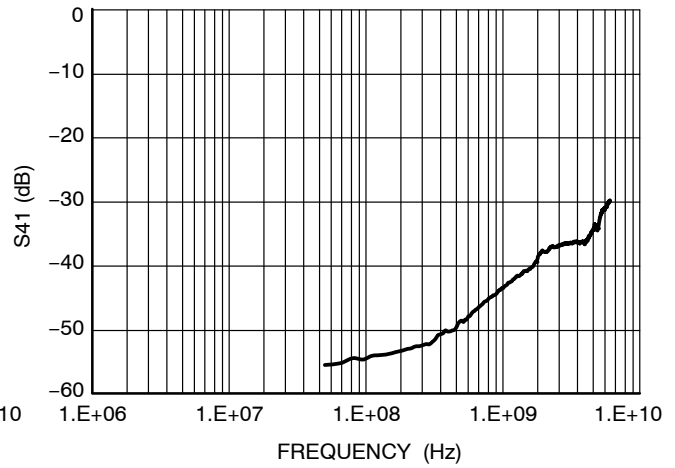


Figure 2. Typical Analog Crosstalk

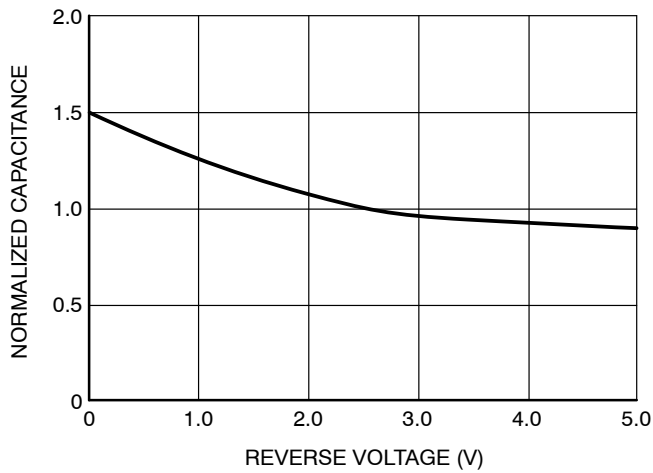


Figure 3. Typical Capacitance vs. Reverse Biased Voltage
(Normalized Capacitance C_d at 2.5 V)

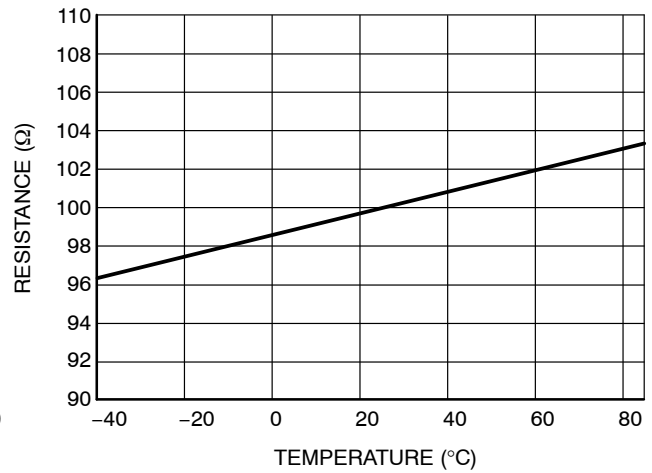


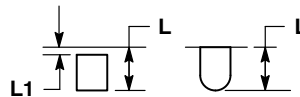
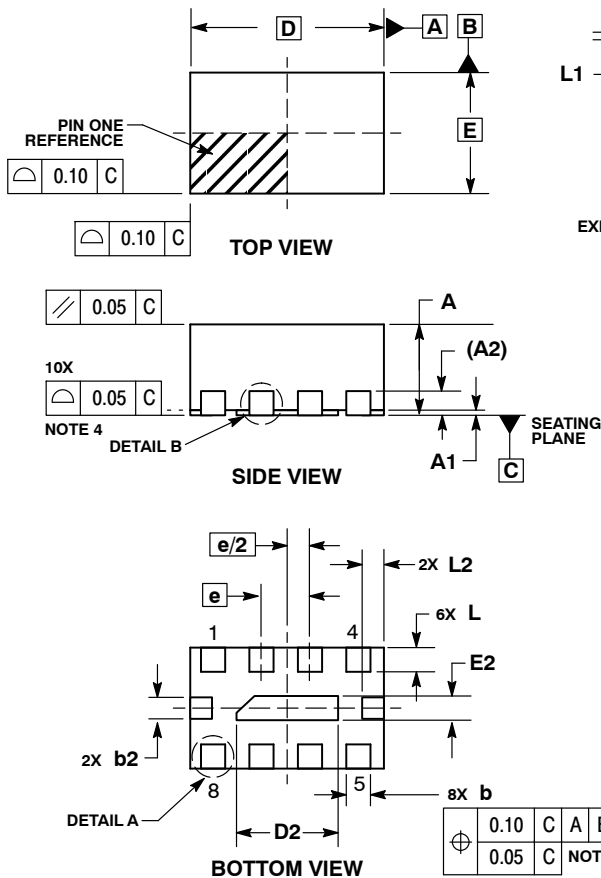
Figure 4. Typical Resistance over Temperature

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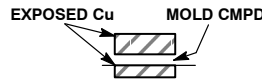
PACKAGE DIMENSIONS

WDFN8, 1.6x1.0, 0.4P
CASE 511AF-01
ISSUE O

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DETAIL A
ALTERNATE TERMINAL
CONSTRUCTIONS



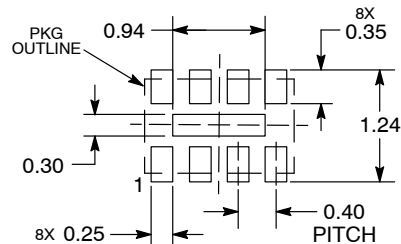
DETAIL B
ALTERNATE
CONSTRUCTION

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND 0.20 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A2	0.20	REF
b	0.15	0.25
b2	0.13	0.23
D	1.60	BSC
D2	0.79	0.89
E	1.00	BSC
E2	0.15	0.25
e	0.40	BSC
L	0.15	0.25
L1	---	0.10
L2	0.13	0.23

MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS

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